



**THE DATASHEET OF  
AUIPS7121R**



### CURRENT SENSE HIGH SIDE SWITCH

#### Features

- Suitable for 24V systems
- Over current shutdown
- Over temperature shutdown
- Current sensing
- Active clamp
- Optimized Turn On/Off for EMI
- Reverse battery protection (Mosfet on)

#### Applications

- 75W Filament lamp
- Solenoid
- 24V loads for trucks

#### Description

The AUIPS7121R is a fully protected five terminal high side switch specifically designed for driving lamp. It features current sensing, over-current, over-temperature, ESD protection and drain to source active clamp. When the input voltage  $V_{cc} - V_{in}$  is higher than the specified threshold, the output power Mosfet is turned on. When the  $V_{cc} - V_{in}$  is lower than the specified  $V_{il}$  threshold, the output Mosfet is turned off. The  $I_{fb}$  pin is used for current sensing. The over-current shutdown is higher than inrush current of the lamp.

#### Product Summary

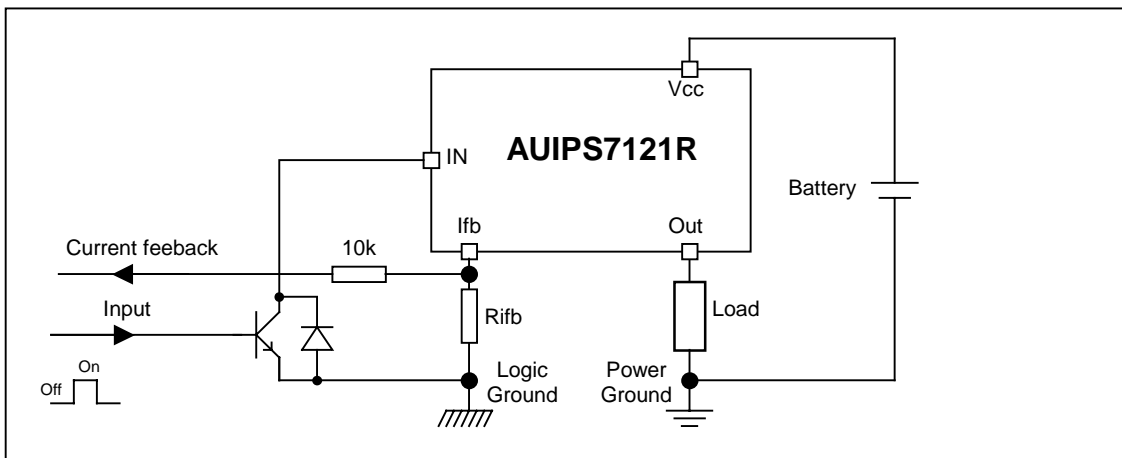
$R_{ds(on)}$	30m $\Omega$ max.
$V_{clamp}$	65V
Current shutdown	50A min.

#### Packages



DPAK

#### Typical Connection



**Qualification Information†**

<b>Qualification Level</b>		Automotive (per AEC-Q100††)
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.
<b>Moisture Sensitivity Level</b>		<p style="text-align: center;">DPAK-5L</p> <p style="text-align: right;">MSL1, 260°C (per IPC/JEDEC J-STD-020)</p>
<b>ESD</b>	Machine Model	Class M2 (200 V) (per AEC-Q100-003)
	Human Body Model	Class H1C (1500 V) (per AEC-Q100-002)
	Charged Device Model	Class C5 (1000 V) (per AEC-Q100-011)
<b>IC Latch-Up Test</b>		Class II, Level A (per AEC-Q100-004)
<b>RoHS Compliant</b>		Yes

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Exceptions to AEC-Q100 requirements are noted in the qualification report.

## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. ( $T_{\text{ambient}}=25^{\circ}\text{C}$  unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-60	Vcc+0.3	V
Vcc-Vin max.	Maximum Vcc voltage	-32	60	V
Iifb, max.	Maximum feedback current	-50	10	mA
Vcc sc	Maximum Vcc voltage with short circuit protection see page 7	—	50	V
Pd	Maximum power dissipation (internally limited by thermal protection) Rth=50°C/W DPack 6cm <sup>2</sup> footprint	—	2.5	W
Tj max.	Max. storage & operating junction temperature	-40	150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
Rth1	Thermal resistance junction to ambient DPak Std footprint	70	—	°C/W
Rth2	Thermal resistance junction to ambient Dpak 6cm <sup>2</sup> footprint	50	—	
Rth3	Thermal resistance junction to case Dpak	2	—	

## Recommended Operating Conditions

These values are given for a quick design.

Symbol	Parameter	Min.	Max.	Units
Iout	Continuous output current, $T_{\text{ambient}}=85^{\circ}\text{C}$ , $T_j=125^{\circ}\text{C}$ Rth=50°C/W, Dpak 6cm <sup>2</sup> footprint	—	3.8	A
Rifb	Iifb resistor	1.5	—	kΩ

## Static Electrical Characteristics

$T_j=25^{\circ}\text{C}$ ,  $V_{cc}=28\text{V}$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
V <sub>cc op.</sub>	Operating voltage range	6	—	60	V	
R <sub>ds(on)</sub>	ON state resistance $T_j=25^{\circ}\text{C}$	—	24	30	m $\Omega$	I <sub>ds</sub> =2A
	ON state resistance $T_j=150^{\circ}\text{C}$ (2)	—	45	55		
I <sub>cc off</sub>	Supply leakage current	—	2	4	$\mu\text{A}$	V <sub>in</sub> =V <sub>cc</sub> =28V, V <sub>ifb</sub> =V <sub>gnd</sub> V <sub>out</sub> =V <sub>gnd</sub>
I <sub>out off</sub>	Output leakage current	—	2	4	$\mu\text{A}$	
I <sub>in on</sub>	Input current when device on	1	2.5	4	mA	V <sub>cc</sub> -V <sub>in</sub> =28V
V <sub>clamp1</sub>	V <sub>cc</sub> to V <sub>out</sub> clamp voltage 1	60	64	—	V	I <sub>d</sub> =10mA
V <sub>clamp2</sub>	V <sub>cc</sub> to V <sub>out</sub> clamp voltage 2	60	65	72		I <sub>d</sub> =20A see fig. 2
V <sub>ih</sub> (1)	High level Input threshold voltage	—	3.5	5.9		I <sub>d</sub> =10mA
V <sub>il</sub> (1)	Low level Input threshold voltage	1.5	3.2	—		
R <sub>ds(on) rev</sub>	Reverse On state resistance $T_j=25^{\circ}\text{C}$	—	25	40	m $\Omega$	I <sub>sd</sub> =2A
V <sub>f</sub>	Forward body diode voltage $T_j=25^{\circ}\text{C}$	—	0.75	0.85	V	I <sub>f</sub> =3A
	Forward body diode voltage $T_j=125^{\circ}\text{C}$	—	0.62	0.7		
R <sub>in</sub>	Input resistor	180	250	350	$\Omega$	

(1) Input thresholds are measured directly between the input pin and the tab.

## Switching Electrical Characteristics

V<sub>cc</sub>=28V, Resistive load=6.8 $\Omega$ ,  $T_j=25^{\circ}\text{C}$

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
t <sub>don</sub>	Turn on delay time	6	15	30	$\mu\text{s}$	See fig. 1
t <sub>r</sub>	Rise time from 20% to 80% of V <sub>cc</sub>	5	10	30		
t <sub>doff</sub>	Turn off delay time	25	50	100	$\mu\text{s}$	
t <sub>f</sub>	Fall time from 80% to 20% of V <sub>cc</sub>	6	15	30		

## Protection Characteristics

$T_j=25^{\circ}\text{C}$ , V<sub>cc</sub>=28V (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
T <sub>sd</sub>	Over temperature threshold(2)	150	165	—	$^{\circ}\text{C}$	See fig. 3 and fig. 11
I <sub>sd</sub>	Over-current shutdown	50	60	80	A	See fig. 3 and page 7
I <sub>fault</sub>	I <sub>fb</sub> after an over-current or an over-temperature (latched)	2.7	3.3	4	mA	See fig. 3

## Current Sensing Characteristics

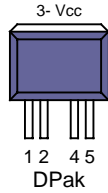
$T_j=25^{\circ}\text{C}$ , V<sub>cc</sub>=28V (unless otherwise specified), V<sub>cc</sub>-V<sub>ifb</sub>>4V

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Ratio	I <sub>load</sub> / I <sub>fb</sub> current ratio	7050	8500	9950		I <sub>load</sub> =5A
Ratio_TC	I <sub>load</sub> / I <sub>fb</sub> variation over temperature(2)	-5%	0	+5	%	$T_j=-40^{\circ}\text{C}$ to $+150^{\circ}\text{C}$
I <sub>offset</sub>	Load current offset	-0.6	0	0.6	A	I <sub>out</sub> <5A
I <sub>fb leakage</sub>	I <sub>fb</sub> leakage current	0	10	100	$\mu\text{A}$	I <sub>out</sub> =0A

(2) Guaranteed by design

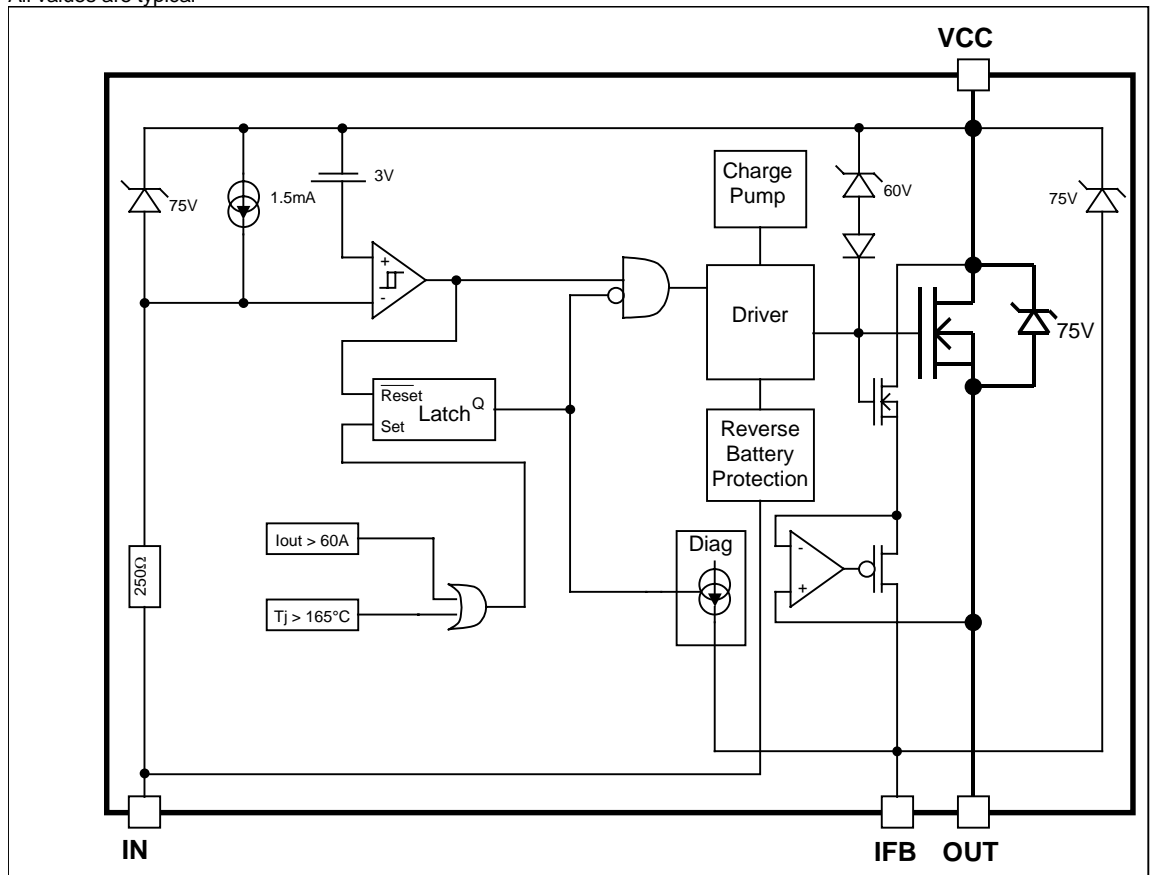
**Lead Assignments**

- 1- NC
- 2- In
- 3- Vcc
- 4- Ifb
- 5- Out



**Functional Block Diagram**

All values are typical



## Truth Table

Op. Conditions	Input	Output	I <sub>fb</sub> pin voltage
Normal mode	H	L	0V
Normal mode	L	H	I <sub>load</sub> x R <sub>fb</sub> / Ratio
Open load	H	L	0V
Open load	L	H	I <sub>fb</sub> leakage x R <sub>fb</sub>
Short circuit to GND	H	L	0V
Short circuit to GND	L	L	I <sub>fault</sub> x R <sub>fb</sub> (latched)
Over temperature	H	L	0V
Over temperature	L	L	I <sub>fault</sub> x R <sub>fb</sub> (latched)

## Operating voltage

**Maximum V<sub>cc</sub> voltage** : this is the maximum voltage before the breakdown of the IC process.

**Operating voltage** : This is the V<sub>cc</sub> range in which the functionality of the part is guaranteed. The AEC-Q100 qualification is run at the maximum operating voltage specified in the datasheet.

## Reverse battery

During the reverse battery the Mosfet is turned on if the input pin is powered with a diode in parallel of the input transistor. Power dissipation in the IPS :  $P = R_{ds(on)} \cdot I_{load}^2 + V_{cc}^2 / 250$  ( internal input resistor ).

If the power dissipation is too high in R<sub>fb</sub>, a diode in serial can be added to block the current.

## Active clamp

The purpose of the active clamp is to limit the voltage across the MOSFET to a value below the body diode break down voltage to reduce the amount of stress on the device during switching.

The temperature increase during active clamp can be estimated as follows:

$$\Delta T_J = P_{CL} \cdot Z_{TH}(t_{CLAMP})$$

Where:  $Z_{TH}(t_{CLAMP})$  is the thermal impedance at  $t_{CLAMP}$  and can be read from the thermal impedance curves given in the data sheets.

$P_{CL} = V_{CL} \cdot I_{CLavg}$  : Power dissipation during active clamp

$V_{CL} = 65V$  : Typical  $V_{CLAMP}$  value

$$I_{CLavg} = \frac{I_{CL}}{2} : \text{Average current during active clamp}$$

$$t_{CL} = \frac{I_{CL}}{\left| \frac{di}{dt} \right|} : \text{Active clamp duration}$$

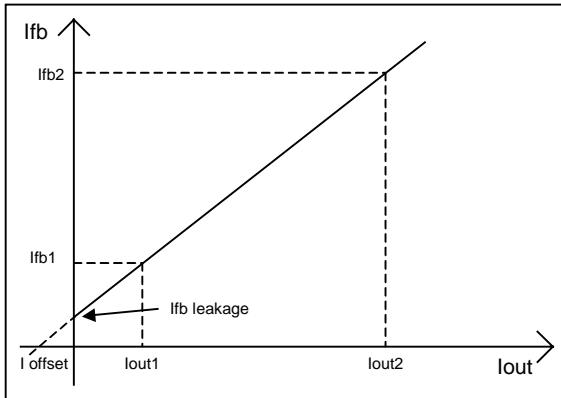
$$\frac{di}{dt} = \frac{V_{Battery} - V_{CL}}{L} : \text{Demagnetization current}$$

Figure 9 gives the maximum inductance versus the load current in the worst case : the part switches off after an over temperature detection. If the load inductance exceeds the curve, a free wheeling diode is required.

## Over-current protection

The threshold of the over-current protection is set in order to guarantee that the device is able to turn on a load with an inrush current lower than the minimum of I<sub>sd</sub>. Nevertheless for high current and high temperature the device may switch off for a lower current due to the over-temperature protection. This behavior is shown in Figure 11.

## Current sensing accuracy



The current sensing is specified by measuring 3 points :

- I\_fb1 for I\_out1
- I\_fb2 for I\_out2
- I\_fb leakage for I\_out=0

The parameters in the datasheet are computed with the following formula :

$$\text{Ratio} = (I_{out2} - I_{out1}) / (I_{fb2} - I_{fb1})$$

$$I_{offset} = I_{fb1} \times \text{Ratio} - I_{out1}$$

This allows the designer to evaluate the I\_fb for any I\_out value using :

$$I_{fb} = (I_{out} + I_{offset}) / \text{Ratio} \text{ if } I_{fb} > I_{fb \text{ leakage}}$$

For some applications, a calibration is required. In that case, the accuracy of the system will depend on the variation of the I\_offset and the ratio over the temperature range. The ratio variation is given by Ratio\_TC specified in page 4.

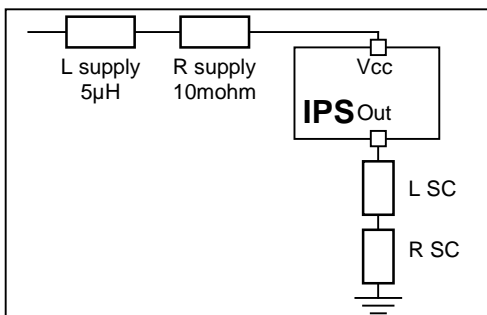
The I\_offset variation depends directly on the R\_dson :

$$I_{offset@-40^\circ\text{C}} = I_{offset@25^\circ\text{C}} / 0.8$$

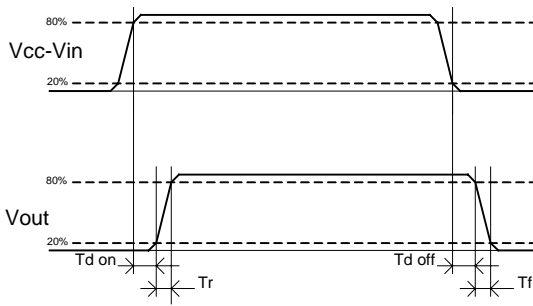
$$I_{offset@150^\circ\text{C}} = I_{offset@25^\circ\text{C}} / 1.9$$

## Maximum Vcc voltage with short circuit protection

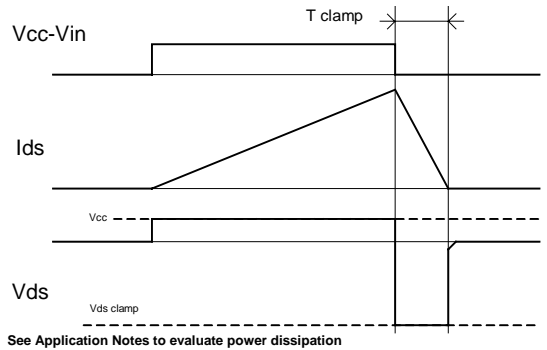
The maximum Vcc voltage with short circuit is the maximum voltage for which the part is able to protect itself under test conditions representative of the application. 2 kind of short circuits are considered : terminal and load short circuit.



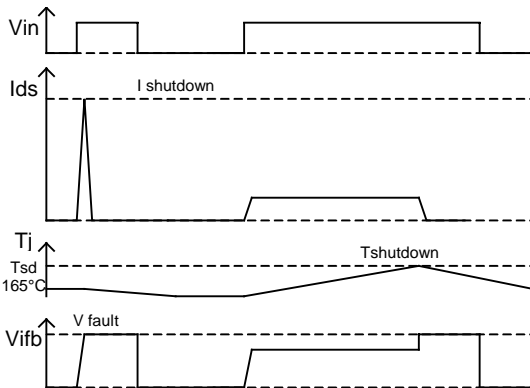
	L SC	R SC
Terminal SC	0.1 µH	10 mohm
Load SC	10 µH	100 mohm



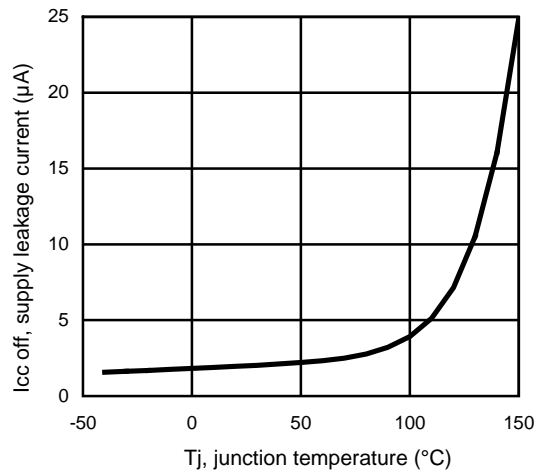
**Figure 1 – IN rise time & switching definitions**



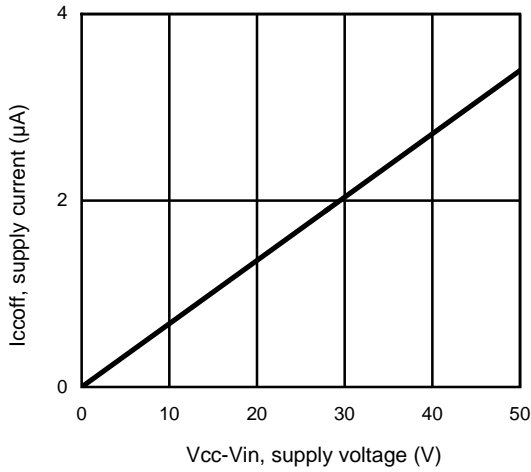
**Figure 2 – Active clamp waveforms**



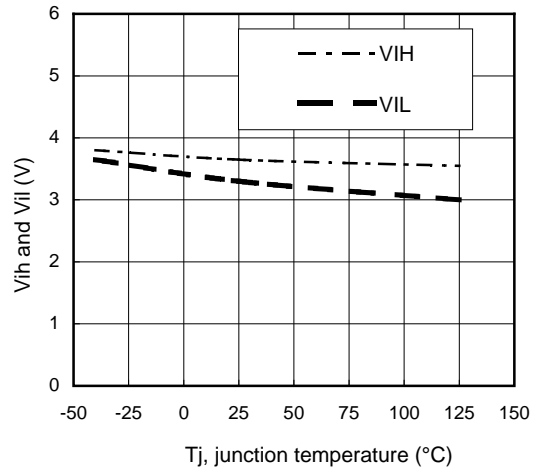
**Figure 3 – Protection timing diagram**



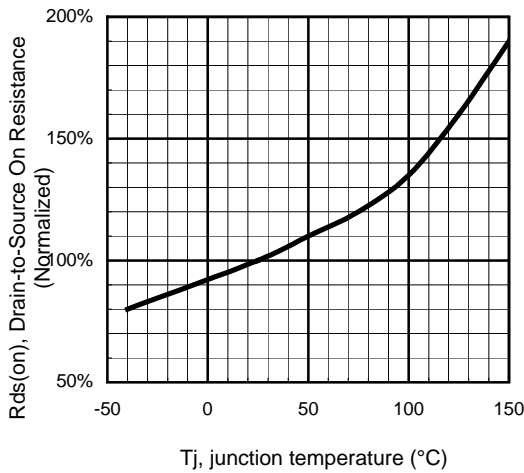
**Figure 4 – Icc off (µA) Vs Tj (°C)**



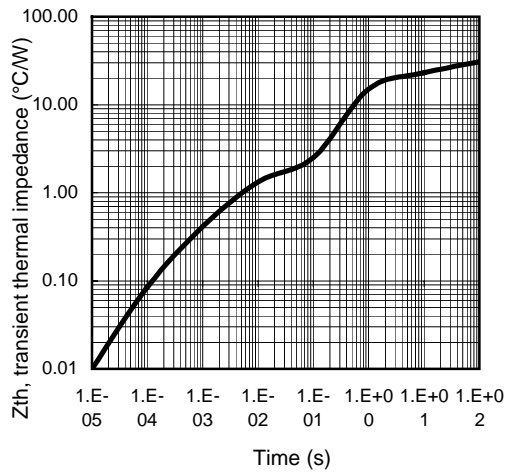
**Figure 5 – Ic off(μA) Vs Vcc-Vin (V)**



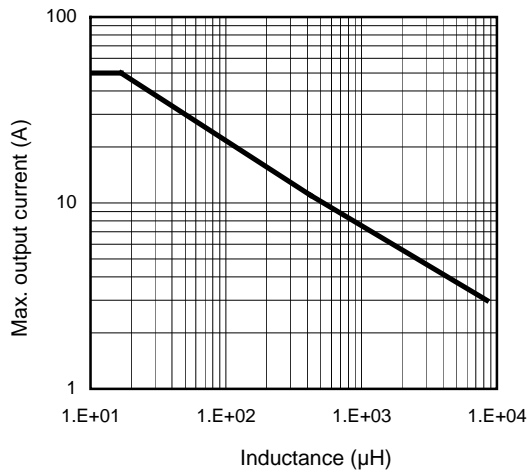
**Figure 6 – Vih and Vil (V) Vs Tj (°C)**



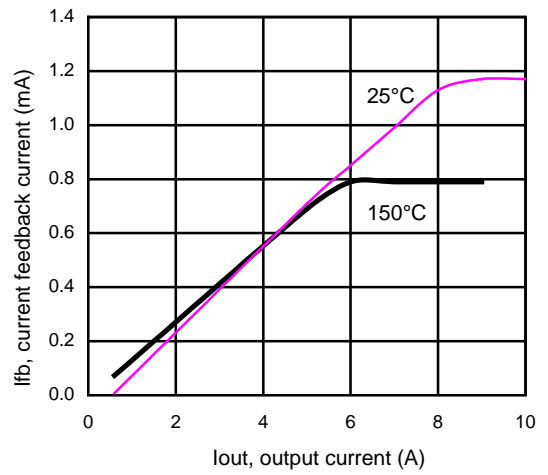
**Figure 7 - Normalized Rds(on) (%) Vs Tj (°C)**



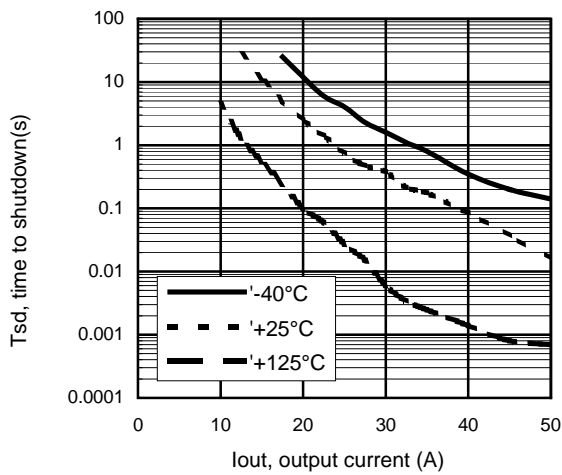
**Figure 8 – Transient thermal impedance (°C/W) Vs time (s)**



**Figure 9 – Max. I<sub>out</sub> (A) Vs inductance (µH)**

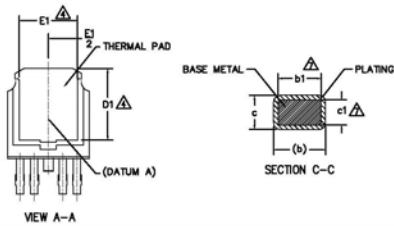
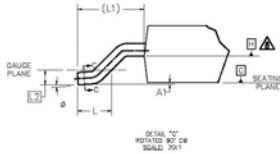


**Figure 10 – I<sub>fb</sub> (mA) Vs I<sub>out</sub> (A)**

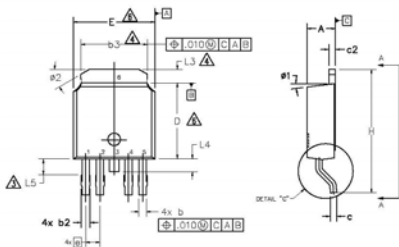


**Figure 11 – T<sub>sd</sub> (s) Vs I<sub>out</sub> (A)  
 SMD with 6cm<sup>2</sup>**

Case Outline 5 Lead – DPAK



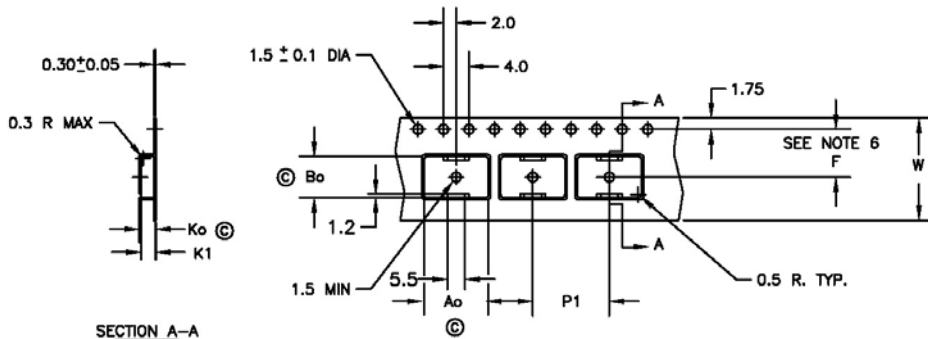
SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	2.18	2.39	.086	.094	
A1	—	0.13	—	.005	
b	0.56	0.79	.022	.031	2
b1	.056	0.74	.022	.029	
b2	0.65	0.89	.026	.035	
b3	4.95	5.46	.195	.215	2
c	0.46	0.61	.018	.024	
c1	0.41	0.56	.016	.022	2
c2	0.46	0.89	.018	.035	
D	5.97	6.22	.235	.245	3
D1	5.21	—	.205	—	
E	6.35	6.73	.250	.265	3
E1	4.32	—	.170	—	
e	1.14 BSC		.045 BSC		
H	9.40	10.41	.370	.410	
L	1.40	1.78	.055	.070	
L1	2.74 BSC		.108 REF.		
L2	0.51 BSC		.020 BSC		
L3	0.89	1.27	.035	.050	
L4	—	1.02	—	.040	
L5	1.14	1.52	.045	.060	
ø	0"	10"	0"	10"	
ø1	0"	15"	0"	15"	
ø2	28"	32"	28"	32"	



NOTES:

- 1.— DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2.— DIMENSION ARE SHOWN IN INCHES [MILLIMETERS]
- 3.— LEAD DIMENSION UNCONTROLLED IN L5.
- 4.— DIMENSION D1, E1, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.— SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- 6.— DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- 7.— DIMENSION b1 & c1 APPLIED TO BASE METAL ONLY.
- 8.— DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 9.— OUTLINE CONFORMS TO JEDEC OUTLINE TO-252.
- 10.— LEADS AND DRAIN ARE PLATED WITH 100% Sn

Tape & Reel 5 Lead – DPAK



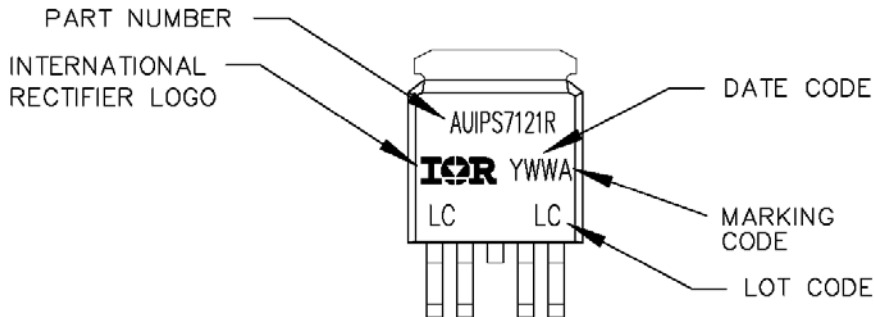
SECTION A-A

$A_o = 10.5 \text{ mm}$   
 $B_o = 7.0 \text{ mm}$   
 $K_o = 2.8 \text{ mm}$   
 $K_1 = 2.4 \text{ mm}$   
 $F = 7.5 \text{ mm}$   
 $P_1 = 12.0 \text{ mm}$   
 $W = 16.0 \pm .3 \text{ mm}$

NOTES:

1. 10 SPROCKET HOLE PUNCH CUMULATIVE TOLERANCE  $\pm 0.02$
2. CAMBER NOT TO EXCEED 1mm IN 100mm
3. MATERIAL: CONDUCTIVE BLACK POLYSTYRENE
4.  $A_o$  AND  $B_o$  MEASURED ON A PLANE 0.3mm ABOVE THE BOTTOM OF THE POCKET
5.  $K_o$  MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
6. POCKET POSITION RELATIVE TO THE SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE
7. VENDOR: (OPTIONAL)
8. MUST ALSO MEET REQUIREMENTS OF EIA STANDARD #EIA-481A, TAPING OF SURFACE-MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT.
9. TOLERANCE TO BE MANUFACTURER STANDARD
10. SURFACE RESISTIVITY OF MOLDED MATL: MUST MEASURE LESS THAN OR EQUAL TO  $10^8$  OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D-257 & ASTM D-991 (REF. C-9000 SPEC.)
11. TOTAL LENGTH PER REEL MUST BE 79 METERS
12. © CRITICAL DIMENSION

## Part Marking Information



## Ordering Information

Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIPS7121R	D-Pak-5-Lead	Tube	75	AUIPS7121R
		Tape and reel	3000	AUIPS7121RTR
		Tape and reel left	2000	AUIPS7121RTRL
		Tape and reel right	2000	AUIPS7121RTRR

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